

[illegible]

As a below-named inventor, I hereby declare that:

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**the specification of which
(check one)**

was filed on _____ as _____

Application Serial No. _____

and was amended on _____ (if applicable)

I acknowledge the duty to disclose information of which I am aware which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Priority Claimed

<u>Number</u>	<u>Country</u>	<u>Filing Date</u>	<u>Yes</u>	<u>No</u>
<u>P2000-239067</u>	<u>Japan</u>	<u>August 7, 2000</u>	<u>X</u>	<u></u>
<u>P2001-102071</u>	<u>Japan</u>	<u>March 30, 2001</u>	<u>X</u>	<u></u>

<u>Application Serial No.</u>	<u>Filing Date</u>	<u>Status</u>
_____	_____	_____
_____	_____	_____

Please address all communications, and direct all telephone calls, regarding this application to

Reg. No. 27,213

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Inventor's signature _____

Citizenship Japanese Date of Signature _____

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